

# SEA & LAND ELECTRONIC CORP.

www.sealand-pptc.com

# **APPROVAL SHEET**

MODEL NO.:	nSMD075-13.2V
CUSTOMER:	
COSTOMER:	
CUSTOMER'S APPR	OVAL:
AUTHORIZED SIGNA	TURE/STAMP:
DATE	
MANUFACTURER:	
HEAD OFFICE:	
	13F.,No.120-10,Sec.3,Zhongshan Rd.,Zhonghe Dist.,New Taipei City 23544,Taiwan

Submitted by: Jay Chen
Approved by: YC Lin
DATE: 2014/12/25

Fax:882-2-2225-7268 E-mail:service@chipfast.com.tw

SEA & LAND ELECTRONIC CORP.



# nSMD075-13.2V

#### Features

- Surface Mount Devices
- Lead free device
- Size 3.2\*1.6 mm/0.12\*0.06 inch
- Surface Mount packaging for automated assembly

#### Applications

protected, including:

Almost anywhere there is a low voltage power supply, up to 60V and a load to be

- Computer mother board, Modem. USB hub
- PDAs & Charger, Analog & digital line card
- Digital cameras, Disk drivers, CD-ROMs,

Performance Specification

Madal	Mandaina	$V_{max}$	<b>I</b> max	I <sub>hold</sub>	I <sub>trip</sub>	$P_d$		mum To Trip	Resis	stance	Agency .	Approval
Model	Marking			@25°C	@25°C	Max.	Current	Time	$Ri_{min}$	R1max	UL	TUV
		(Vdc)	(A)	(A)	(A)	(W)	(A)	(Sec)	(Ω)	$(\Omega)$	OL	100
nSMD075-13.2V	αG	13.2	100	0.75	1.50	0.6	8.00	0.20	0.090	0.500		

**Ihold** = Hold Current. Maximum current device will not trip in 25°C still air.

Itrip = Trip Current. Minimum current at which the device will always trip in 25°C still air.

Vmax = Maximum operating voltage device can withstand without damage at rated current (Imax).

Imax = Maximum fault current device can withstand without damage at rated voltage (Vmax).

Pd = Power dissipation when device is in the tripped state in 25°C still air environment at rated voltage.

Rimin/max = Minimum/Maximum device resistance prior to tripping at 25°C.

R1<sub>max</sub> = Maximum device resistance is measured one hour post reflow.

**CAUTION**: Operation beyond the specified ratings may result in damage and possible arcing and flame.

#### **Environmental Specifications**

Test	Conditions	Resistance change				
Passive aging	+85°C, 1000 hrs.	±5% typical				
Humidity aging	+85°C, 85% R.H., 168 hours	±5% typical				
Thermal shock	+85°C to -40°C, 20 times	±33% typical				
Resistance to solvent	MIL-STD-202,Method 215	No change				
Vibration	MIL-STD-202,Method 201	No change				
Ambient operating conditions : -40 °C to 85 °C						
Maximum surface temperature of the device in the tripped state is 125 °C						

Agency Approvals : UL pending

Regulation/Standard: (PS) RoHS 2002/95/EC

**HF** EN14582

#### I<sub>hold</sub> Versus Temperature

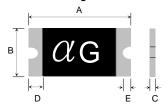
•	nold voicus i cimporatu									
	Model		Max	timum ambie	ent operating	temperature	e (T <sub>mao</sub> ) vs. h	old current (	(I <sub>hold</sub> )	
	Model	-40°C	-20°C	0°C	25°C	40°C	50°C	60°C	70°C	85°C
Г	nSMD075-13.2\/	1 11	1.01	0.88	0.75	0.65	0.50	0.54	0.40	0.41

# nSMD075-13.2V

#### Construction And Dimension (Unit:mm)

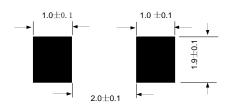
Model		A		В		С		E
Model	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Min.
nSMD075-13.2V	3.00	3.50	1.50	1.80	0.50	1.20	0.15	0.10

#### **Dimensions & Marking**



α = Trademark G = Part identification

#### Recommended Pad Layout (mm)



#### **Termination Pad Characteristics**

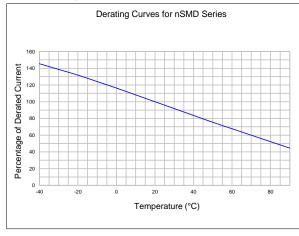
Tin-plated Nickel-Copper Terminal pad materials:

Terminal pad solderability: Meets EIA specification RS186-9E and ANSI/J-STD-002 Category 3.

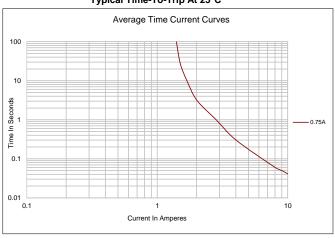
Rework

Use standard industry practices, the removal device must be replaced with a fresh one.

#### **Thermal Derating Curve**

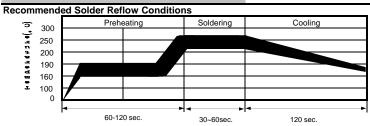


#### Typical Time-To-Trip At 25°C



# WARNING:

# nSMD075-13.2V

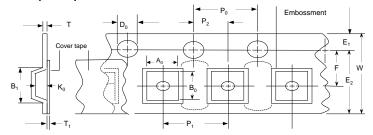


- · Recommended reflow methods: IR, vapor phase oven, hot air oven.
- Devices are not designed to be wave soldered to the bottom side
- of the board.
- Recommended maximum paste thickness is 0.25 mm (0.010 inch).
- Devices can be cleaned using standard method and solvents.
- Note: If reflow temperatures exceed the recommended profile, devices may not meet the performance requirements.

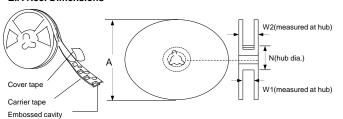
#### Tape And Reel Specifications (mm)

Governing Specifications	EIA 481-1
W	8.15 ± 0.3
P0	4.0 ± 0.10
P1	$4.0 \pm 0.10$
P2	$2.0 \pm 0.05$
A0	1.95 ± 0.10
B0	3.45 ± 0.10
B1max.	4.35
D0	1.5 + 0.1, -0
F	$3.5 \pm 0.05$
E1	1.75 ± 0.10
E2min.	6.25
Tmax.	0.6
T1max.	0.1
K0	1.04 ± 0.1
Leader min.	390
Trailer min.	160
Reel Dimensions	
A max.	178
N min.	60
W1	9 ± 0.5
W2	12.6 ± 0.5
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# **EIA Tape Component Dimensions**



#### **EIA Reel Dimensions**



# Storage And Handling

- Storage conditions : 40°C max, 70% R.H.
- Devices may not meet specified performance if storage conditions are exceeded.

# Order Information Packaging nSMD 075 -13.2V Tape & Reel Quantity Product name Hold Max Size 3216 mm / 1206 inch Current Voltage 3500 pcs/reel SMD: surface mount device 0.75A 3500 pcs/reel

Tape & reel packaging per EIA481-1

#### Labeling Information

